



AO4826

Dual N-Channel Enhancement Mode Field Effect Transistor

General Description

The AO4826 uses advanced trench technology to provide excellent R_{DS(ON)} and low gate charge. This device is suitable for use as a load switch or in PWM applications. Standard Product AO4826 is Pb-free (meets ROHS & Sony 259 specifications). AO4826L is a Green Product ordering option. AO4826 and AO4826L are electrically identical.

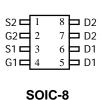
Features

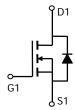
 $V_{DS}(V) = 60V$

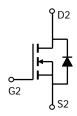
 $I_D = 6.3A (V_{GS} = 10V)$

 $R_{DS(ON)}$ < 25m Ω (V_{GS} = 10V)

 $R_{DS(ON)}$ < 30m Ω (V_{GS} = 4.5V)







Absolute Maximum Ratings T _A =25°C unless otherwise noted							
Parameter		Symbol	Maximum	Units			
Drain-Source Voltage		V_{DS}	60	V			
Gate-Source Voltage		V_{GS}	±20	V			
Continuous Drain	T _A =25°C		6.3				
Current ^A	T _A =70°C	I_D	5	Α			
Pulsed Drain Current ^B		I _{DM}	40				
	T _A =25°C	P_{D}	2	W			
Power Dissipation	T _A =70°C	T D	1.28	VV			
Junction and Storage Temperature Range		T_J , T_{STG}	-55 to 150	°C			

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{\theta JA}$	50	62.5	°C/W			
Maximum Junction-to-Ambient ^A	Steady-State	$\kappa_{\theta JA}$	73	110	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	31	40	°C/W			

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
STATIC F	PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V		60			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =48V, V _{GS} =0V			1		
	Zero Gate Voltage Drain Current		T _J =55°C			5	μΑ
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±20V				100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_D=250 \mu A$		1	2.1	3	V
$I_{D(ON)}$	On state drain current	V _{GS} =10V, V _{DS} =5V		40			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	V_{GS} =10V, I_D =6.3A			20	25	m_{Ω}
			T _J =125°C		34	42	11122
		V _{GS} =4.5V, I _D =5.7A		22	30	mΩ	
g _{FS}	Forward Transconductance	V_{DS} =5V, I_{D} =6.3A		27		S	
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V			0.74	1	V
Is	Maximum Body-Diode Continuous Current					3	Α
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =30V, f=1MHz			1920	2300	pF
Coss	Output Capacitance				155		pF
C_{rss}	Reverse Transfer Capacitance				116		pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			0.65	0.8	Ω
SWITCHI	NG PARAMETERS						
$Q_g(10V)$	Total Gate Charge	V _{GS} =10V, V _{DS} =30V, I _D =6.3A			47.6	58	nC
$Q_g(4.5V)$	Total Gate Charge				24.2	30	nC
Q_{gs}	Gate Source Charge				6		nC
Q_{gd}	Gate Drain Charge				14.4		nC
$t_{D(on)}$	Turn-On DelayTime				7.6		ns
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =30V, R_L =4.7 Ω , R_{GEN} =3 Ω			5		ns
t _{D(off)}	Turn-Off DelayTime				28.9		ns
t _f	Turn-Off Fall Time				5.5		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =6.3A, dI/dt=100A/μs			33.2	40	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =6.3A, dI/dt=100A/μs			43		nC

A: The value of $R_{\theta,UA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

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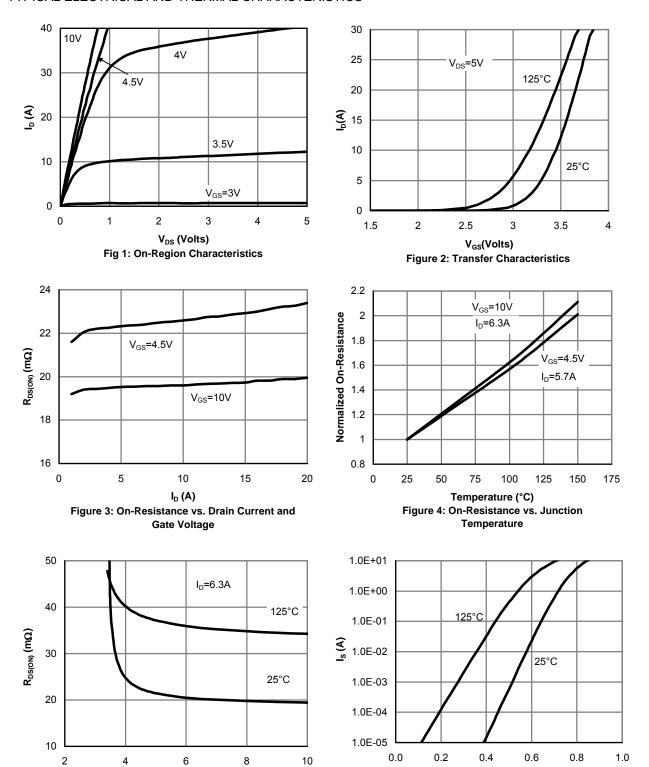
B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using $80\mu s$ pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



V_{SD} (Volts)

Figure 6: Body-Diode Characteristics

V_{GS} (Volts)

Figure 5: On-Resistance vs. Gate-Source Voltage

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

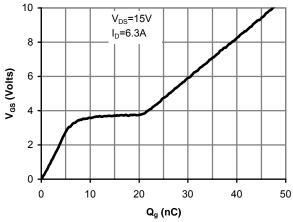


Figure 7: Gate-Charge Characteristics

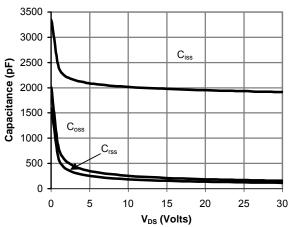


Figure 8: Capacitance Characteristics

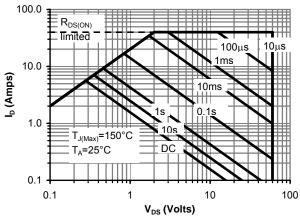


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

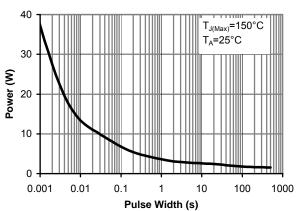


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

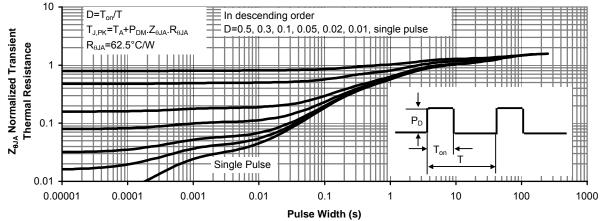


Figure 11: Normalized Maximum Transient Thermal Impedance